



#### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-30V	35mΩ@-10V	-5A
	55mΩ@-4.5V	

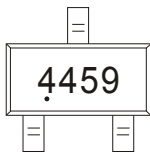
#### Feature

- Trench Power MOSFET
- Excellent  $R_{DS(ON)}$

#### Application

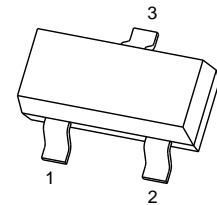
- Load Switch
- Battery Protection Applications

#### MARKING:



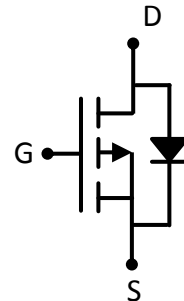
4459 = Device Cpde  
 Solid Dot = Green Molding Compound Device,  
 Otherwise Normal Device

#### SOT-23



1. GATE
2. SOURCE
3. DRAIN

#### Schematic diagram



#### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	-5.0	A
Plused Drain Current	$I_{DM}$	-20	A
Maximum Power Dissipation	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	357	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}C$

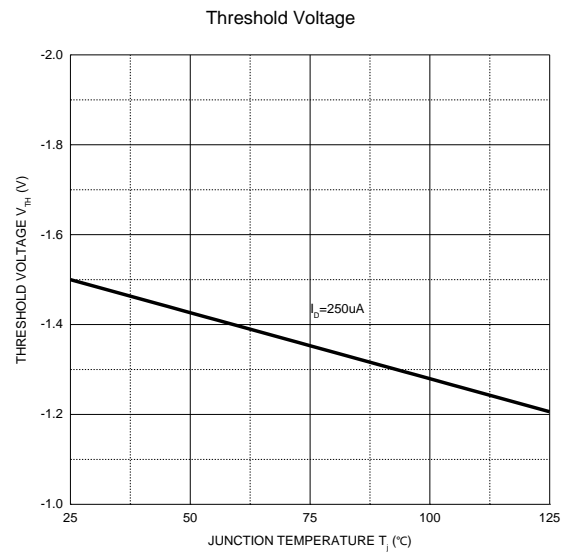
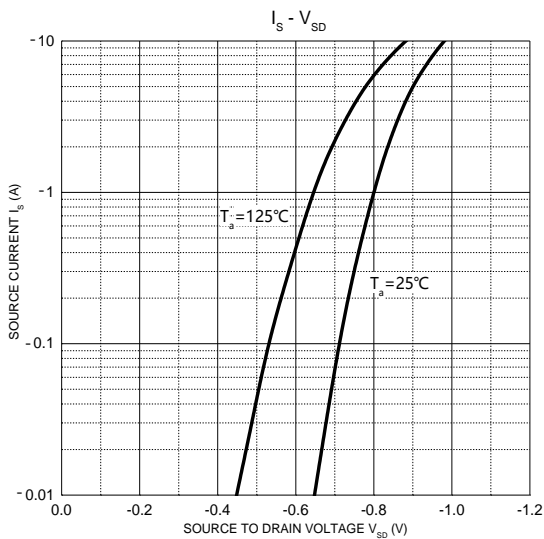
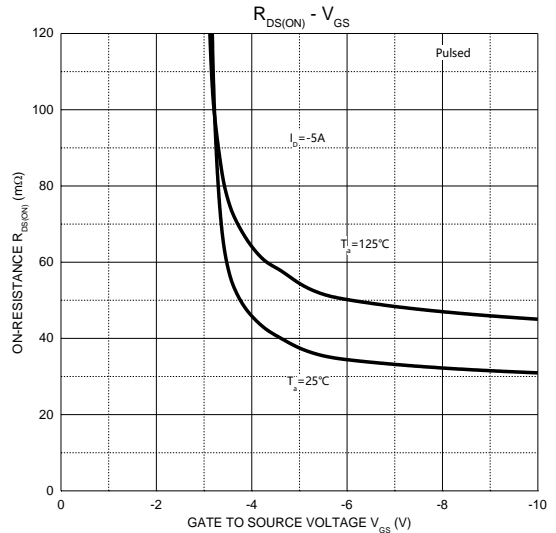
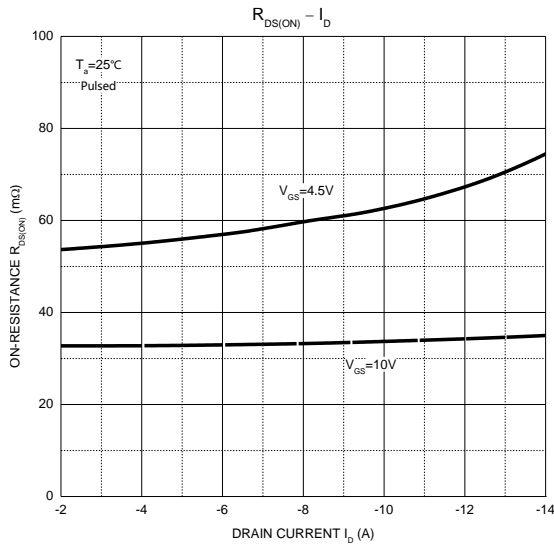
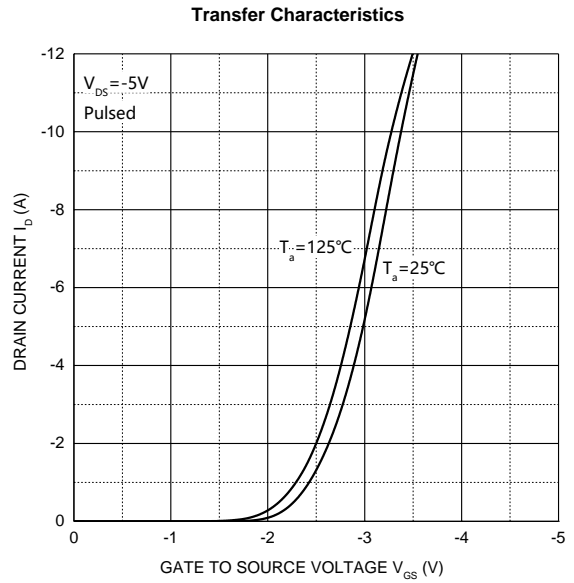
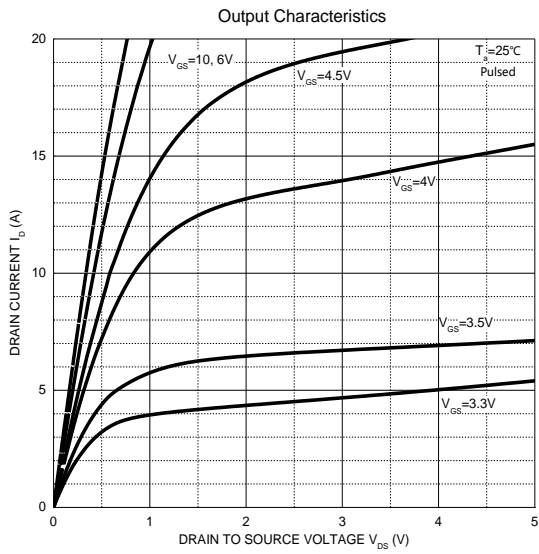
**MOSFET ELECTRICAL CHARACTERISTICS(T<sub>a</sub>=25°C unless otherwise noted)**

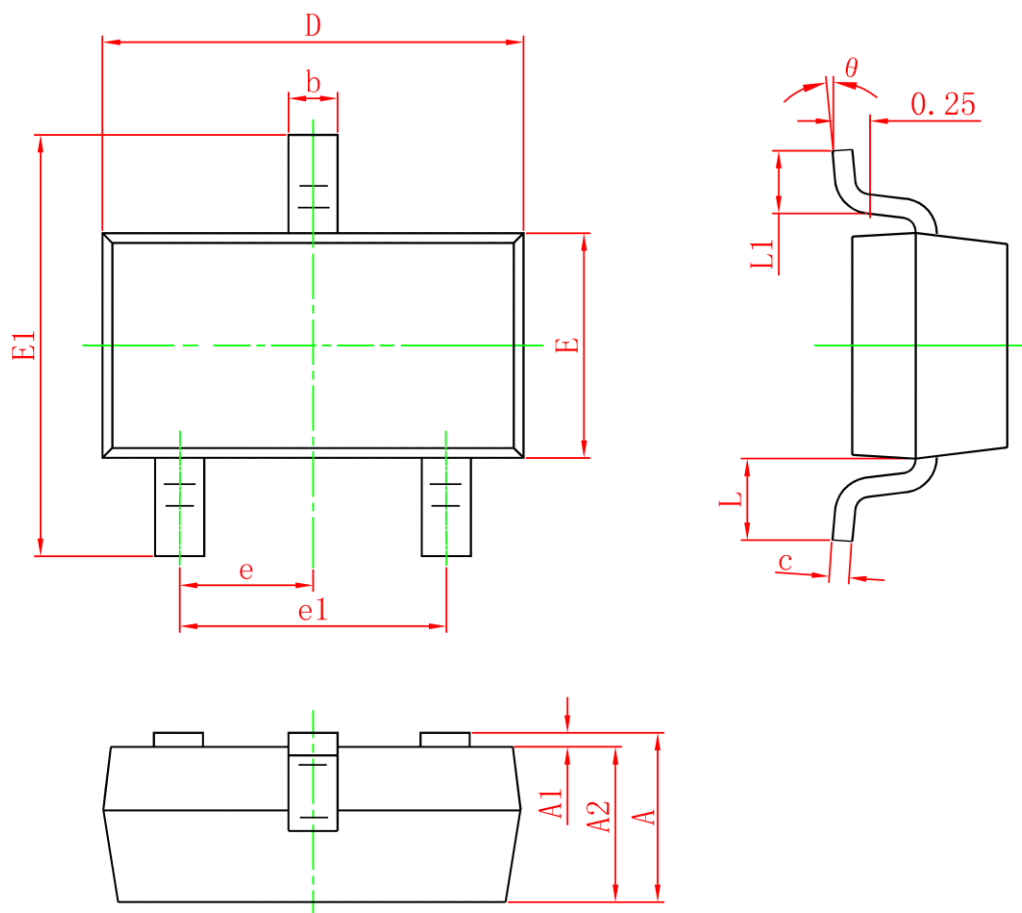
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-30			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V			-1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Gate threshold voltage <sup>1</sup>	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.5	-2.5	V
Drain-source on-resistance <sup>1</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A		35	46	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A		55	72	
Forward tranconductance <sup>1</sup>	g <sub>FS</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -5A	10			S
<b>Dynamic characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V, f = 1MHz		850		pF
Output Capacitance	C <sub>oss</sub>			100		
Reverse Transfer Capacitance	C <sub>rss</sub>			70		
<b>Switching Characteristics</b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V, R <sub>L</sub> = 2.5Ω, R <sub>GEN</sub> = 3Ω		9		ns
Turn-on rise time	t <sub>r</sub>			7		
Turn-off delay time	t <sub>d(off)</sub>			25		
Turn-off fall time	t <sub>f</sub>			10		
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A		12		nC
Gate-source charge	Q <sub>gs</sub>			2.5		
Gate-drain charge	Q <sub>gd</sub>			4		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage <sup>1</sup>	V <sub>DS</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A			-1.2	V

**Notes:**

1 Pulse Test : Pulse width ≤ 300μs, duty cycle ≤ 2%.

**Typical Electrical and Thermal Characteristics**



**SOT-23 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0	0.100	0	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.150	1.500	0.045	0.059
E1	2.250	2.650	0.089	0.104
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
$\theta$	0°	8°	0°	8°